



## 200V N-Channel MOSFET

**Pb** Lead Free Package and Finish

### General Features

- Proprietary New Planar Technology
- $R_{DS(ON),typ.}=50m\ \Omega@V_{GS}=10V$
- Low Gate Charge Minimize Switching Loss
- Fast Recovery Body Diode

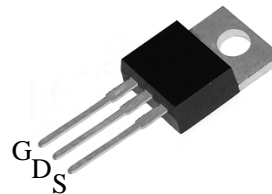
### Applications

- DC-DC Converters
- DC-AC Inverters for UPS
- SMPS and Motor controls

### Ordering Information

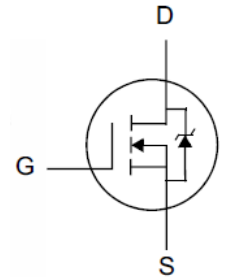
Part Number	Package	Brand
PTP40N20	TO-220	<b>i</b>

$BV_{DSS}$	$R_{DS(ON),typ.}$	$I_D$
200V	50m $\Omega$	40A



TO-220

Package Not to Scale



### Absolute Maximum Ratings

$T_C=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	PTP40N20	Unit
$V_{DSS}$	Drain-to-Source Voltage <sup>[1]</sup>	200	V
$V_{GSS}$	Gate-to-Source Voltage	$\pm 20$	
$I_D$	Continuous Drain Current	40	A
$I_D @ T_C=100^\circ\text{C}$	Continuous Drain Current @ $T_C=100^\circ\text{C}$	Figure 3	
$I_{DM}$	Pulsed Drain Current at $V_{GS}=10V$ <sup>[2]</sup>	Figure 6	
$E_{AS}$	Single Pulse Avalanche Energy	1200	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ <sup>[3]</sup>	5.0	V/ns
$P_D$	Power Dissipation	125	W
	Derating Factor above $25^\circ\text{C}$	1.0	W/ $^\circ\text{C}$
$T_L$ $T_{PAK}$	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds	300 260	$^\circ\text{C}$
$T_J$ & $T_{STG}$	Operating and Storage Temperature Range	-55 to 150	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

### Thermal Characteristics

Symbol	Parameter	PTP40N20	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.0	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62	



## Electrical Characteristics

### OFF Characteristics $T_J = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	200	--	--	V	$V_{GS}=0V, I_D=250\mu A$
$I_{DSS}$	Drain-to-Source Leakage Current	--	--	1	uA	$V_{DS}=200V, V_{GS}=0V$
		--	--	100		$V_{DS}=160V, V_{GS}=0V, T_J=125^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Leakage Current	--	--	+100	nA	$V_{GS}=+20V, V_{DS}=0V$
		--	--	-100		$V_{GS}=-20V, V_{DS}=0V$

### ON Characteristics

$T_J = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$R_{DS(ON)}$	Static Drain-to-Source On-Resistance <sup>[4]</sup>	--	50	65	mΩ	$V_{GS}=10V, I_D=20A$
$V_{GS(TH)}$	Gate Threshold Voltage	2.0	--	4.0	V	$V_{DS}=V_{GS}, I_D=250\mu A$
gfs	Forward Transconductance <sup>[4]</sup>	--	65	--	S	$V_{DS}=15V, I_D=20A$

### Dynamic Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$C_{iss}$	Input Capacitance	--	2800	3700	pF	$V_{GS}=0V, V_{DS}=25V, f=1.0\text{MHz}$
$C_{rss}$	Reverse Transfer Capacitance	--	110	150		
$C_{oss}$	Output Capacitance	--	305	400		
$Q_g$	Total Gate Charge	--	97	120	nC	$V_{DD}=100V, I_D=20A, V_{GS}=0 \text{ to } 10V$
$Q_{gs}$	Gate-to-Source Charge	--	14	--		
$Q_{gd}$	Gate-to-Drain (Miller) Charge	--	39	--		

### Resistive Switching Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$t_{d(ON)}$	Turn-on Delay Time	--	20	--	nS	$V_{DD}=100V, I_D=20A, V_{GS}=10V, R_G=3.9\Omega$
$t_{rise}$	Rise Time	--	30	--		
$t_{d(OFF)}$	Turn-Off Delay Time	--	65	--		
$t_{fall}$	Fall Time	--	25	--		

**Source-Drain Body Diode Characteristics** $T_J=25^{\circ}\text{C}$  unless otherwise specified

Symbol	Parameter	Min	Typ.	Max.	Unit	Test Conditions
$I_{SD}$	Continuous Source Current <sup>[4]</sup>	--	--	40	A	Integral PN-diode in MOSFET
$I_{SM}$	Pulsed Source Current <sup>[4]</sup>	--	--	160		
$V_{SD}$	Diode Forward Voltage	--	--	1.5	V	$I_S=40\text{A}$ , $V_{GS}=0\text{V}$
trr	Reverse recovery time	--	280	--	ns	$V_{GS}=0\text{V}$ , $I_F=20\text{A}$ , $di_F/dt=100\text{A}/\mu\text{s}$
Qrr	Reverse recovery charge	--	420	--	nC	

**Note:**

[1]  $T_J=+25^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$

[2] Repetitive rating; pulse width limited by maximum junction temperature.

[3]  $I_{SD}=20\text{A}$   $di/dt < 100\text{A}/\mu\text{s}$ ,  $V_{DD} < BV_{DSS}$ ,  $T_J=+150^{\circ}\text{C}$ .

[4] Pulse width  $\leq 380\mu\text{s}$ ; duty cycle  $\leq 2\%$ .



## Typical Characteristics

Figure 1. Maximum Effective Thermal Impedance, Junction-to-Case

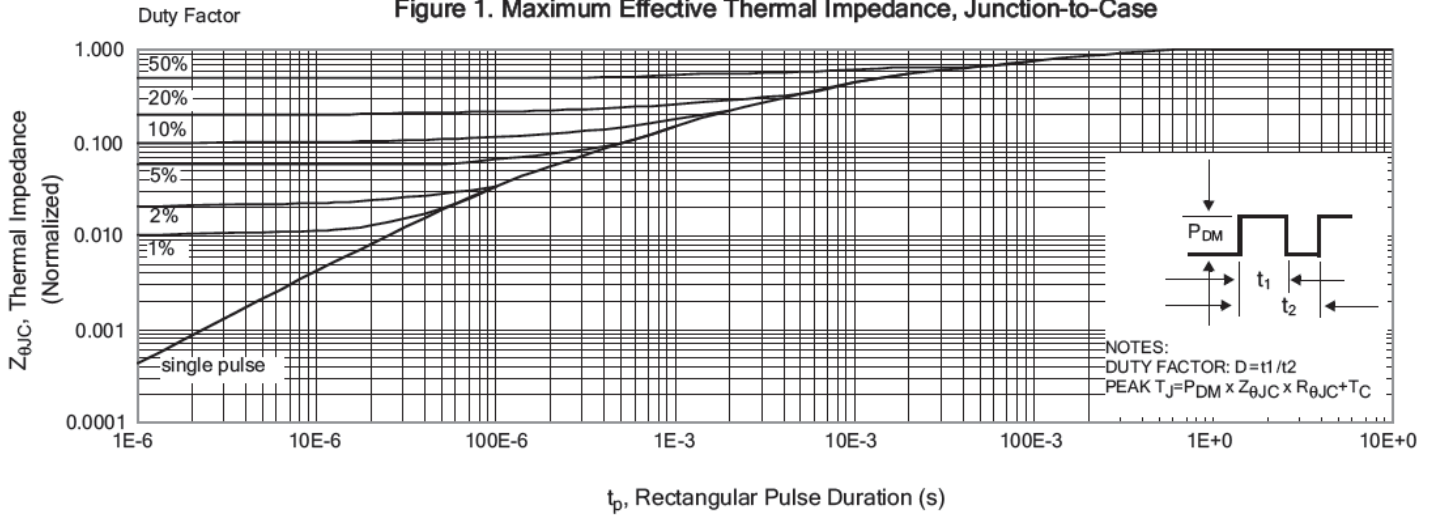


Figure 2. Maximum Power Dissipation vs Case Temperature

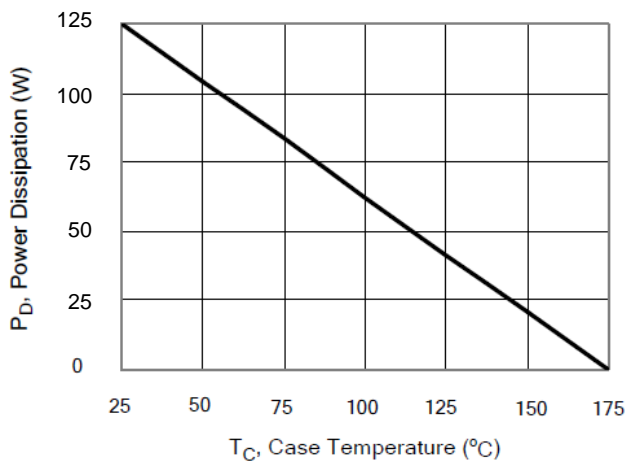


Figure 3. Maximum Continuous Drain Current vs Case Temperature

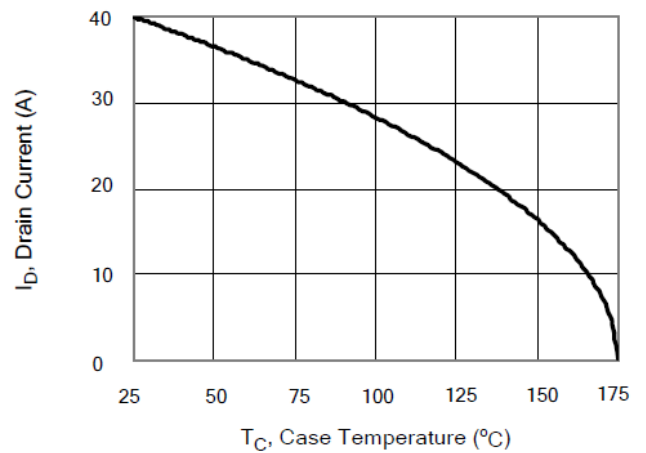


Figure 4. Typical Output Characteristics

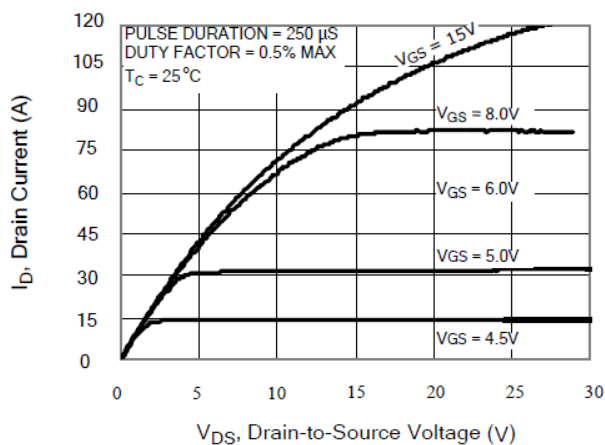
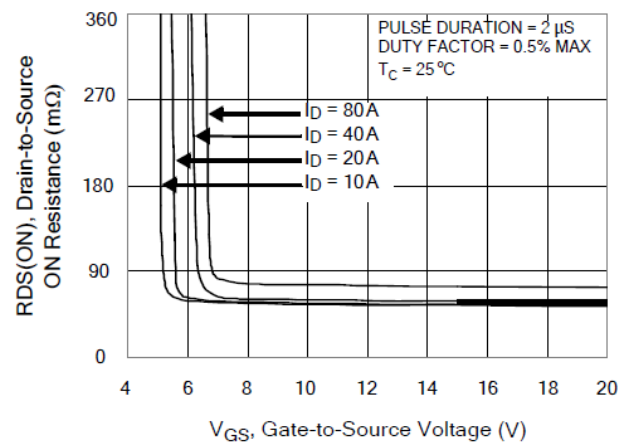


Figure 5. Typical Drain-to-Source ON Resistance vs Gate Voltage and Drain Current





### Typical Characteristics(Cont.)

Figure 6. Maximum Peak Current Capability

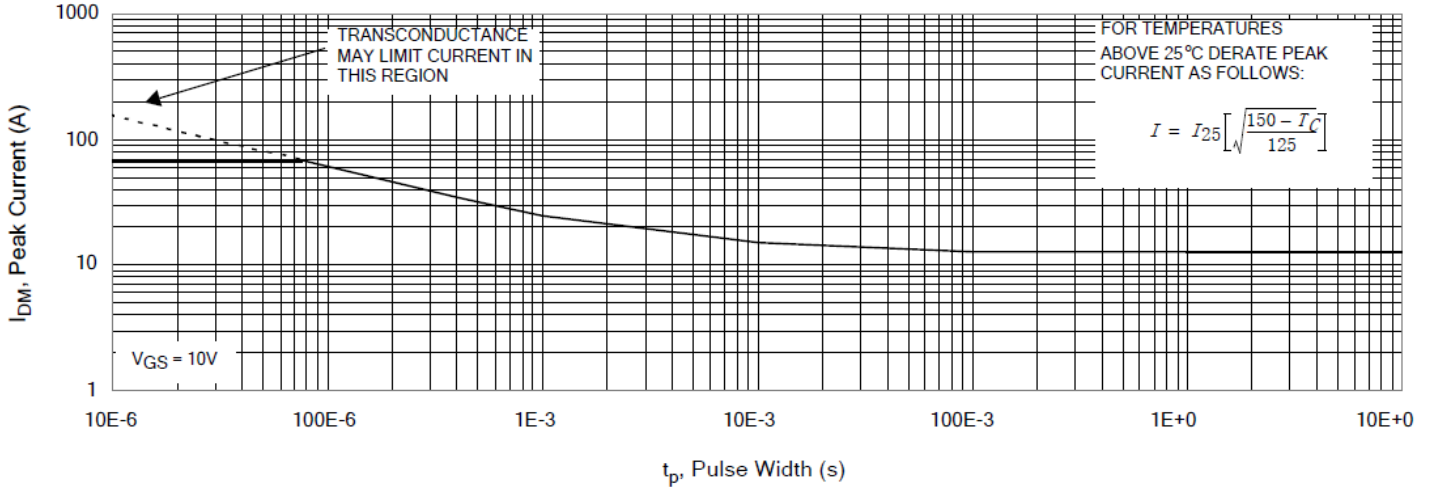


Figure 7. Typical Transfer Characteristics

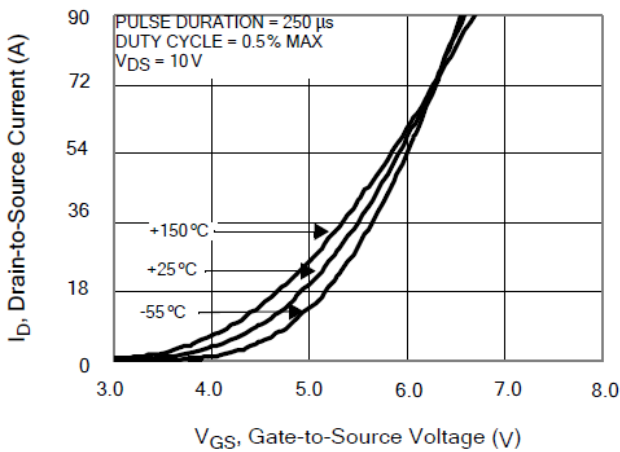


Figure 8. Unclamped Inductive Switching Capability

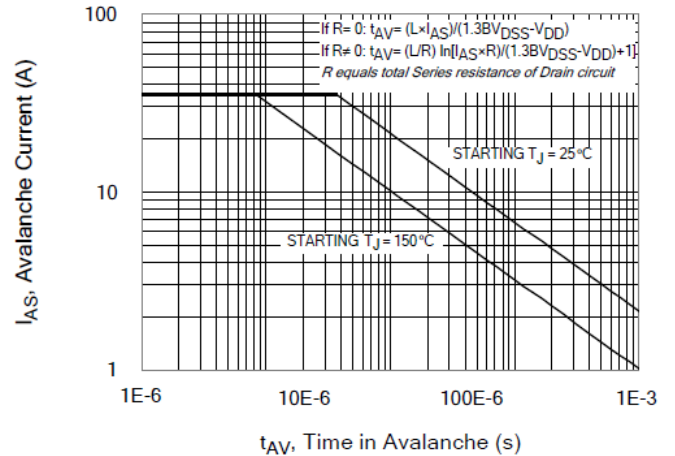


Figure 9. Typical Drain-to-Source ON Resistance vs Drain Current

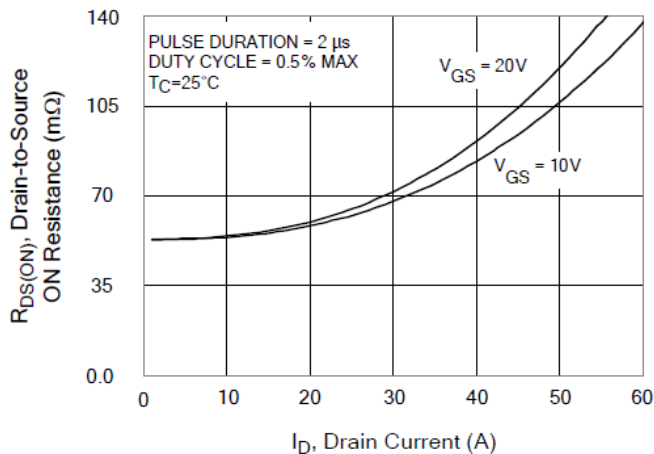
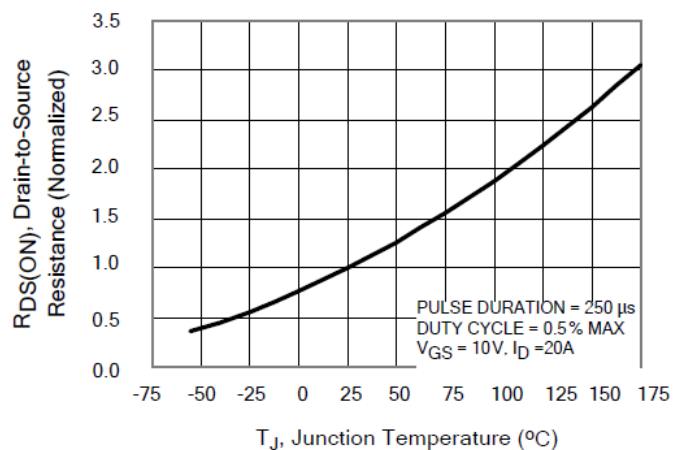


Figure 10. Typical Drain-to-Source ON Resistance vs Junction Temperature





### Typical Characteristics(Cont.)

Figure 11. Typical Breakdown Voltage vs Junction Temperature

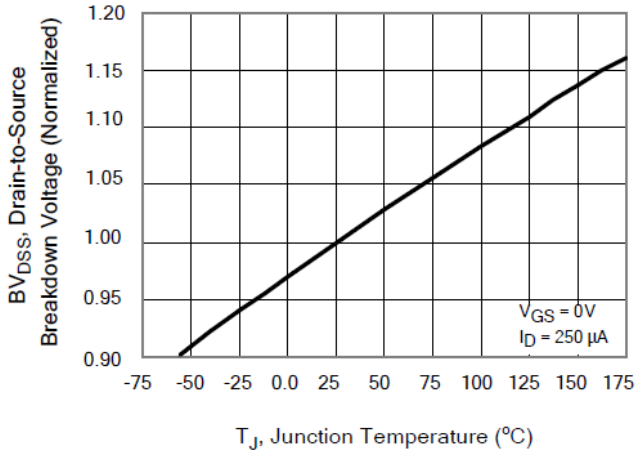


Figure 12. Typical Threshold Voltage vs Junction Temperature

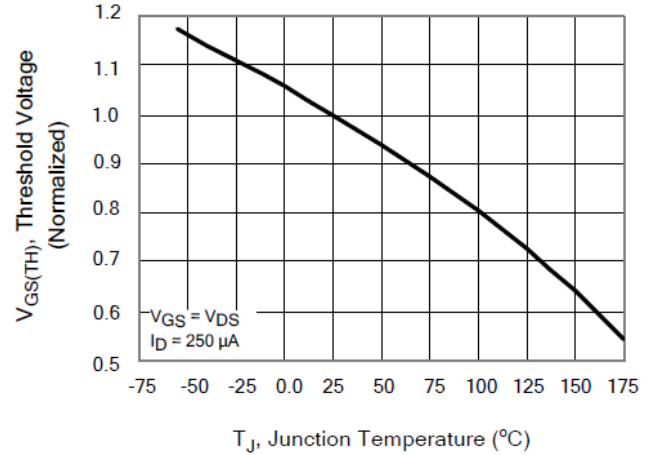


Figure 13. Maximum Forward Bias Safe Operating Area

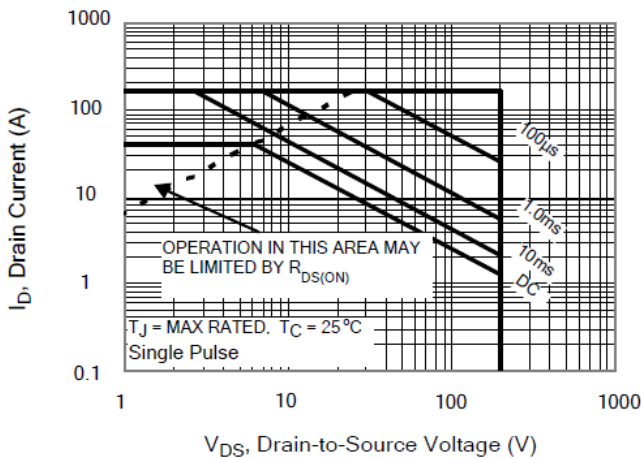


Figure 14. Typical Capacitance vs Drain-to-Source Voltage

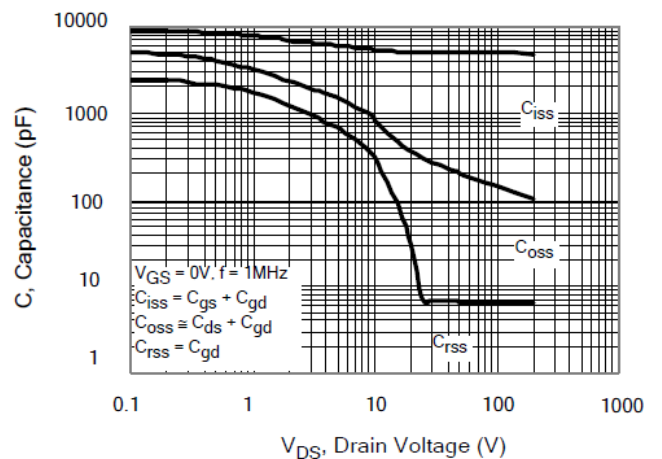


Figure 15. Typical Gate Charge

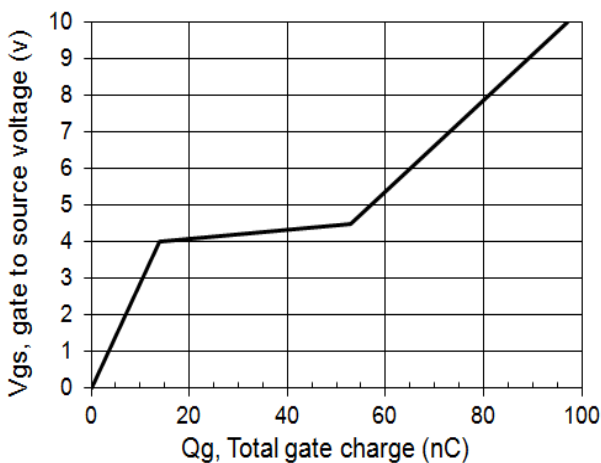
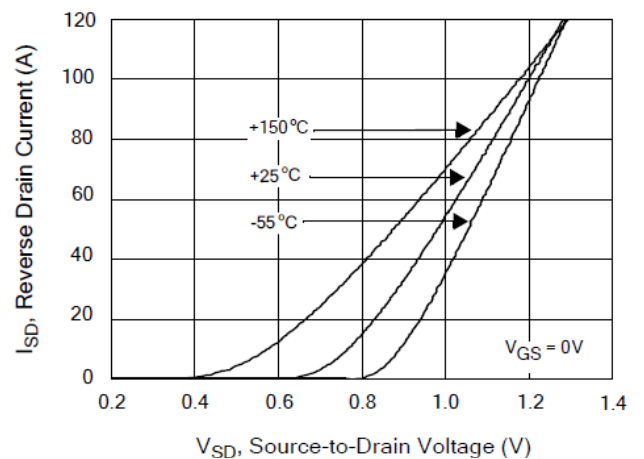


Figure 16. Typical Body Diode Transfer Characteristics





### Test Circuits and Waveforms

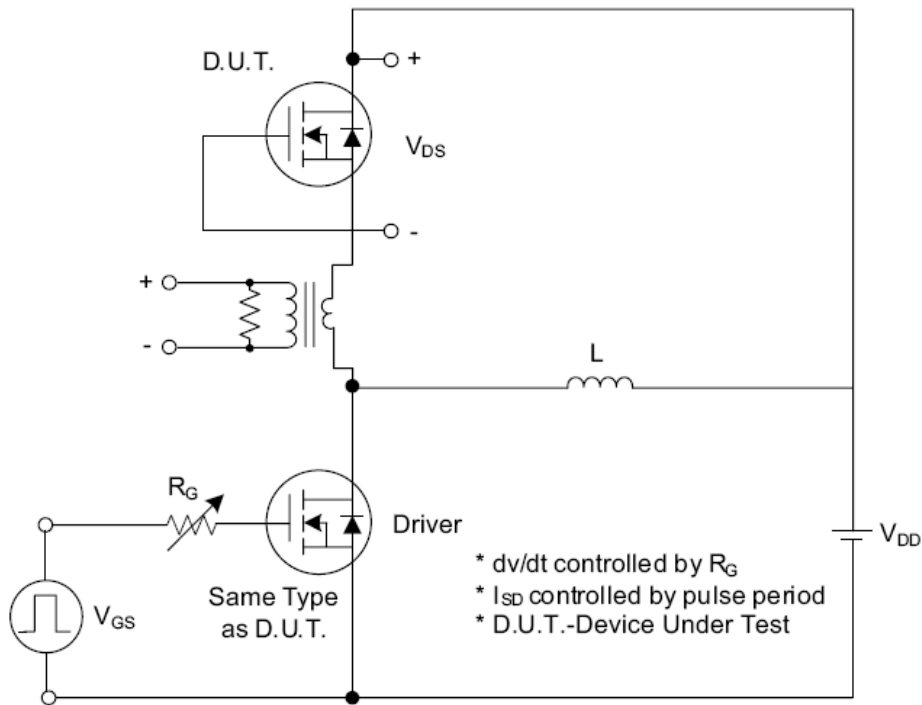


Fig. 1.1 Peak Diode Recovery  $dv/dt$  Test Circuit

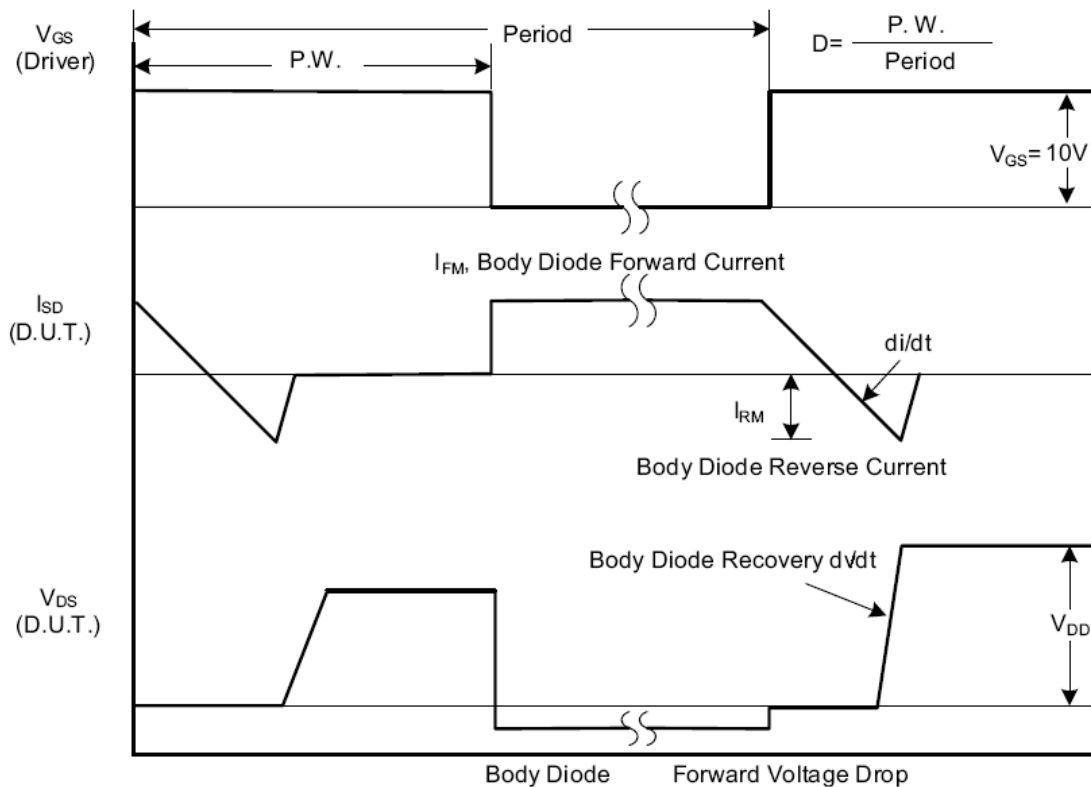


Fig. 1.2 Peak Diode Recovery  $dv/dt$  Waveforms



### Test Circuits and Waveforms (Cont.)

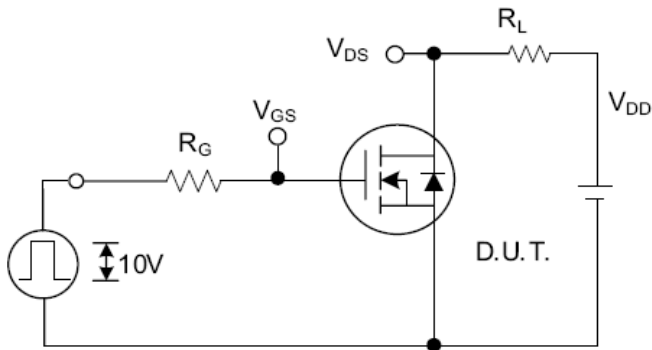


Fig. 2.1 Switching Test Circuit

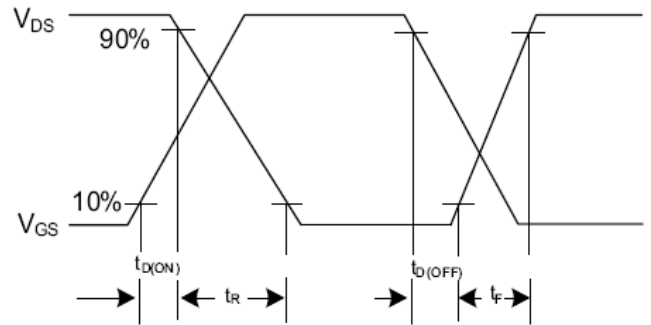


Fig. 2.2 Switching Waveforms

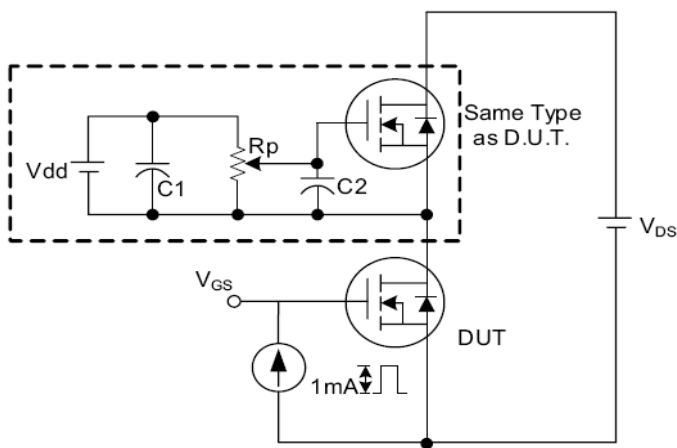


Fig. 3.1 Gate Charge Test Circuit

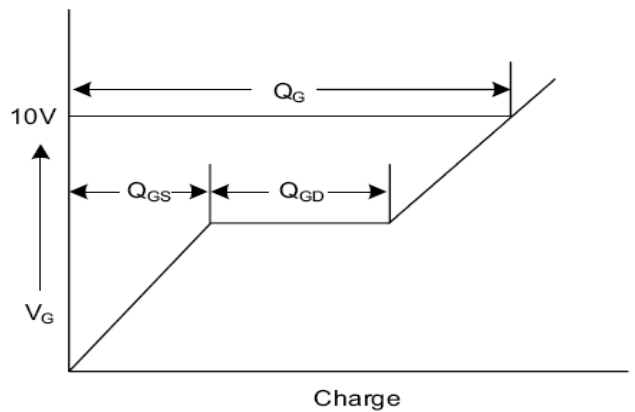


Fig. 3.2 Gate Charge Waveform

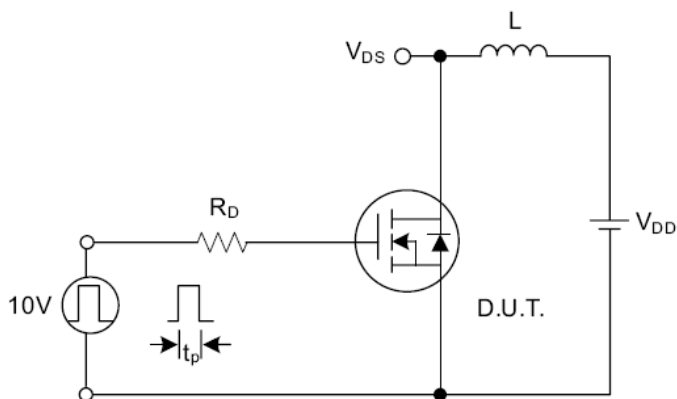


Fig. 4.1 Unclamped Inductive Switching Test Circuit

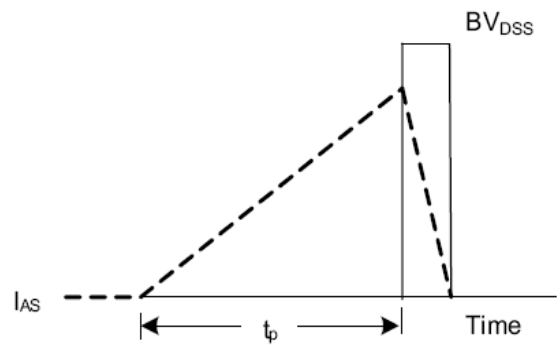


Fig. 4.2 Unclamped Inductive Switching Waveforms





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